

2815
ifw

PATENT
3430-0131P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:	Kwang-Jo HWANG	Conf.:	5562
Appl. No.:	09/648,111	Group:	2815
Filed:	August 25, 2000	Examiner:	P. Brock, II
For:	METHOD OF PATTERNING A METAL LAYER IN A SEMICONDUCTOR DEVICE		

LARGE ENTITY TRANSMITTAL FORM

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

June 15, 2004

Sir:

Transmitted herewith is an amendment in the above-identified application.

- ☐ The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.
- ☐ The enclosed document is being transmitted via facsimile.

The fee has been calculated as shown below:

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR		PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	30	-	30	=	0	\$ 18	\$0.00
INDEPENDENT	4	-	4	=	0	\$ 86	\$0.00
<input type="checkbox"/> FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$290	\$0.00
						TOTAL	\$0.00

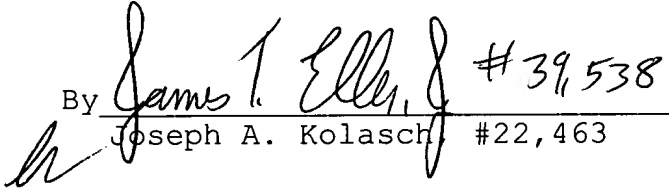

- ☐ Petition for () month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.
- ☒ No fee is required.
- ☐ Check(s) in the amount of \$0.00 is(are) enclosed.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.


If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By

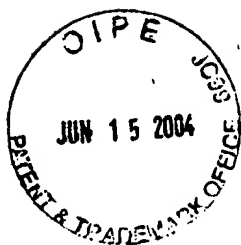
 #39,538
 Joseph A. Kolasch #22,463


JAK/PLS:jls
3430-0131P

P.O. Box 747
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Attachment(s)

(Rev. 02/08/2004)



PATENT
3430-0131P

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S): HWANG, Kwang-Jo CONF.: 5562
SERIAL NO.: 09/648,111 GROUP: 2815
FILED: August 25, 2000 EXAMINER: BROCK II, P.
FOR: METHOD OF PATTERNING A METAL LAYER IN A
SEMICONDUCTOR DEVICE

AMENDMENT UNDER 37 C.F.R. 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

June 15, 2004

Dear Sir:

In response to the non-final Office Action dated March 15, 2004, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes Amendments to the Claims and Remarks.